

A Highly Integrated USB Audio Single Chip

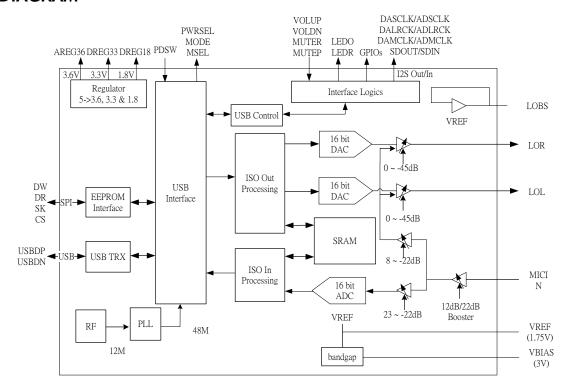
DESCRIPTION

The CM108B is a highly integrated crystal-free USB audio single chip solution optimized for USB headset, headphone, and dongle applications. The CM108B comes with software driver interface supports XearTM sound effects multimedia entertainments. All essential analog modules are embedded in the CM108B, including dual DAC and earphone driver, ADC, microphone booster, PLL, regulator and USB transceiver modules. Many features are programmable with jumper pins or by external EEPROM. Audio adjustments are easily controlled via specific HID-compliant volume control pins. An external codec or audio DSP can be connected to the CM108B via I2S pin for further processing. Vendors can customize unique USB VID/PID/Product String/Manufacture String and min/max/initial volumes to EEPROM. The CM108B also comes with an anti-pop noise circuits design and internal oscillator which can operate without an external crystal oscillator.

FEATURES

- Compliant with USB 2.0 Full Speed Operation
- Compliant with USB Audio Device Class Specification v1.0
- Supports USB Suspend/Resume Mode and Remote Wakeup with Volume Control pins
- On-chip oscillator that provides reference sources for PLL and embedded USB transceiver
- Jumper pin for Headset Mode (Playback + Recording) and Speaker/Headphone Mode (Playback Only)
- Jumper pin for Mixer Unit enable/disable under Headset Mode and Power Mode setting
- I2S interfaces for external CODEC
- Anti-pop noise design for plugged and vice-versa
- Support XearTM Audio Centre Software Driver for Windows OS

BLOCK DIAGRAM



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Release notes

Revision	Date	Description
1.00	31 Oct 2013	First release
1.11	18 Nov 2014	Correction on page 6 diagram

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1 Description and overview

The CM108B is a highly integrated single-chip USB audio solution. All essential analog modules are embedded in the CM108B, including dual DAC and earphone driver, ADC, microphone booster, PLL, regulator and USB transceiver modules. It is perfectly suited to USB headset, USB earphone or USB audio-interface box applications. As well, many features are programmable with jumper pins or by external EEPROM.

The CM108B can connect to an external codec or audio DSP via I2S pins for further processing. Plus, 3 GPIO pins can be accessed with customer application software for additional value-adding applications. In addition, audio adjustments can be easily controlled via specific HID compliant volume control pins. Many features are programmable with jumper pins or external EEPROM. Vendors can customize unique USB VID/PID/Product String/Manufacture String and max/min/initial volumes to EEPROM. The CM108B also comes with an anti-pop noise circuits design and internal oscillator which can operate without an external crystal oscillator.

2 Ordering information

Model No.	Package	Operating Ambient Temperature	Supply Range
CM108B	48-pin LQFP, 7mm × 7mm × 1.4mm (plastic)	-20°C to +70°C	DVdd = 5V, AVdd = 5V

3 Features

- Supports USB 2.0 full speed operation
- Compliant with USB audio device class specification 1.0
- Supports USB suspend/resume modes and remote wakeup with volume control pins
- On-chip oscillator that provides reference sources for PLL and embedded USB transceiver
- Support XearTM audio driver for multimedia sound effects in Windows OS, for further information please refer to CM108B XearTM Audio Center Driver User's Manual
- Jumper pin for speaker mode (playback only) or headset mode (playback plus recording)
- For headset mode, USB audio function topology has 2 input terminals, 2 output terminals, 1 mixer unit, 1 selector unit and 3 feature units
- Jumper pin allows for mixer unit enable/disable when in headset mode
- For speaker mode, the USB audio topology has 1 input terminal, 1 output terminal and 1 feature unit
- Supports one control endpoint, one isochroous OUT endpoint, one isochroous IN endpoint, and one interrupt IN endpoint
- Alternate zero bandwidth setting for releasing playback bandwidth on USB Bus when device is inactive
- Anti-pop noise design for device plugged and vice-versa, while A-A path is off
- Supports AES/EBU, IEC60958, S/PDIF consumer formats for stereo PCM data at S/PDIF output
- Volume up, volume down, and playback mute pins support USB HID for host control synchronization
- Record mute pin with LED indicator for record mute status
- Includes external EEPROM Interface for Vendor Specific USB VID, PID, Product String, Manufacture String, and max/min/initial volumes
- 3 GPIO pins with read/write via HID interface
- Jumper pin to set the power mode (100mA or 500mA, Bus-powered or self-powered)
- Isochronous transfer uses adaptive mode with internal PLL for synchronization
- 48K/44.1KHz sampling rate for both playback and recording
- Soft mute function





- Embedded 16-bit ADC input with microphone boost
- Embedded power-on reset block
- Embedded 5V to 3.6V/3.3V/1.8V regulators for single external 5V power
- 48-pin LQFP package

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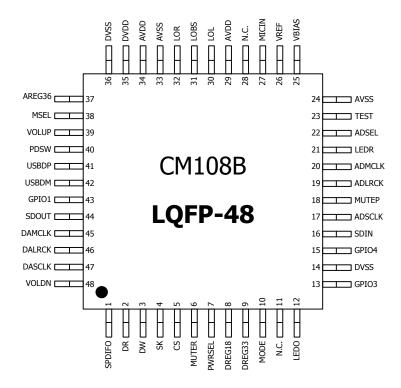


4 Pin descriptions

4.1 Pin assignment by pin number

Pin #	Signal Name						
1	SPDIFO	13	GPIO3	25	VBIAS	37	AREG36
2	DR	14	DVSS	26	VREF	38	MSEL
3	DW	15	GPIO4	27	MICIN	39	VOLUP
4	SK	16	SDIN	28	N.C.	40	PDSW
5	CS	17	ADSCLS	29	AVDD	41	USBDP
6	MUTER	18	MUTEP	30	LOL	42	USBDM
7	PWRSEL	19	ADLRCK	31	LOBS	43	GPIO1
8	DREG18	20	ADMCLK	32	LOR	44	SDOUT
9	DREG33	21	LEDR	33	AVSS	45	DAMCLK
10	MODE	22	ADSEL	34	AVDD	46	DALRCK
11	N.C.	23	TEST	35	DVDD	47	DASCLK
12	LEDO	24	AVSS	36	DVSS	48	VOLDN

4.2 Pin-out diagram



Pin Assignments (top view)



4.3 Pin signal descriptions

Pin #	Symbol	Туре	Description	
1	SPDIFO	DO, 4mA, SR	SPDIF output	
2	DR	DI, 8mA, PD, 5VT	EEPROM interface data read from EEPROM	
3	DW	DO, 4mA, SR	EEPROM interface data write to EEPROM	
4	SK	DO, 4mA, SR	EEPROM interface clock	
5	CS	DO, 4mA, SR	EEPROM interface chip select	
6	MUTER	DI, ST, PU	Mute recording (edge trigger with de-bouncing)	
7	PWRSEL	DI, ST, PU	Chip power select pin: H: push up to 3.3V, L: push down to ground Speaker mode - H: 100mA self-powered, L: 500mA Bus-powered Headset mode - H: 100mA Bus-powered L: 500mA Bus-powered	
8	DREG18	P	1.8V Regulator Output for Digital Core	
9	DREG33	Р	3.3V Regulator Output for Digital I/O (driving current 40mA)	
10	MODE	DI, ST, PD	Operating mode selection: H: push up to 3.3V, L: pull down to ground H: speaker mode - playback only L: headset mode - playback & recording	
11	N.C.			
12	LEDO	DO, SR, 4mA	LED operation light: output H for power on, toggling for data transmit	
13	GPIO3	DIO, 8mA, PD, 5VT	GPIO pin	
14	DVSS	P	Digital ground	
15	GPIO4	DIO, 8mA, PD, 5VT	·	
16	SDIN	DIO, 8mA, PD, 5VT	ADC I2S data input	
17	ADSCLK	DO, 2mA, SR	ADC I2S serial clock	
18	MUTEP	DI, ST, PU	Mute playback (edge trigger with de-bouncing)	
19	ADLRCK	DO, 2mA, SR	ADC I2S left/right clock	
20	ADMCLK	DO, 2mA, SR	11.2896MHz output for 44.1KHz sampled data and 12.288MHz output for 48KHz sampled data	
21	LEDR	DO, SR, 4mA	LED for mute recording indicator, output H when recording is muted	
22	ADSEL	DI, ST, PD	ADC input source select pin H: use external (via I2S) ADC L: use internal ADC (H: push up to 3.3V, L: push down to ground)	
23	TEST	DI, ST, PD	Test mode select pin, H: test mode L: normal operation (H: push up to 3.3V, L: push down to ground)	
24	AVSS	P	Analog ground	
25 26	VBIAS VREF	AO AO	Microphone bias voltage supply (3V), with a small driving capability Connecting to external decoupling capacitor for embedded bandgap	
27	MICINI	A 1	circuit, 1.75V output	
27	MICIN	Al	Microphone input, input impedance is 10k Ohm	
28 29	N.C. AVDD	P	EV analog power for analog circuit	
30	LOL	AO	5V analog power for analog circuit Line out: left channel	
31	LOBS	AO	DC 1.75V output for line out bias	
32	LOR	AO	Line out: right channel	
33	AVSS	P	Analog ground	
34	AVDD	P	5V power supply for analog circuit	
35	DVDD	P	5V power supply for internal regulator	
36	DVSS	P	Digital ground	
37	AREG36	P	3.6V analog power for analog circuit	
-,	000			





			Mixer enable select:
			H: push up to 3.3V, L: push down to ground
38	MSEL		H: with mixer/AA-path enabled (with default mute)
		, - , -	L: without mixer/AA-path disabled
			USB descriptors will also be changed accordingly
39	VOLUP	DI, ST, PU	Volume up (edge trigger with de-bouncing)
39	VULUP		
			Power down switch control signal (for PMOS polarity)
40	PDSW	DO, 4mA, OD	0: normal operation
			1: power down mode (suspend mode)
41	USBDP	AIO	USB Data D+
42	USBDM	AIO	USB Data D-
43	GPIO1	DIO, 8mA, PD, 5VT	GPIO pin
44	SDOUT	DO, 2mA, SR	DAC I2S data output
45	DAMCIK	DO 2 4 CD	11.2896 MHz output for 44.1KHz sampled data and
45	DAMCLK	DO, 2mA, SR	12.288 MHz output for 48KHz sampled data
46	DALRCK	DO, 2mA, SR	DAC I2S left/right clock
47	DASCLK	DO, 2mA, SR	DAC I2S serial clock
48	VOLDN	DI, ST, PU	Volume down (edge trigger with de-bouncing)

NoteU: DI / DO / DIO - Digital Input / Output / Bi-Directional Pad

Al / AO / AlO - Analog Input / Output / Bi-Directional Pad

SR - Slew Rate Control

ST - Schmitt Trigger

PD / PU - Pull Down / Pull Up

5VT - 5 Volt Tolerant (3.3V Pad)

OD - Open Drain

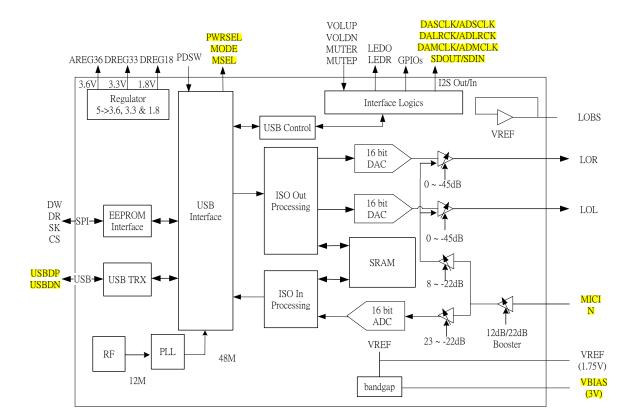
P - Power Supply Pin

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5 Block diagram



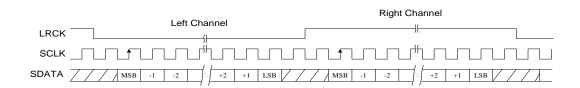
CM108B Block Diagram



6 I2S Interface

The CM108B provides an I2S interface for both playback and recording. External ADC, DAC, or DSP can be added to provide additional functions within the USB audio system. The CM108B sends out master clock (fixed at x256), LRCK (fixed at x64), and data clock data. Therefore, external ADCs, DACs, or DSPs should be set to slave mode.

The left channel of the CM108B's I2S bus is used for mono recording. Both IP^{2P}S buses use a 5V tolerant pad in order to easily interface with 5V or 3.3V devices. Playback data is simultaneously sent to both the DAC and I2S bus. The recording source (ADC or I2S bus) can be selected by ADSEL jumper pin.





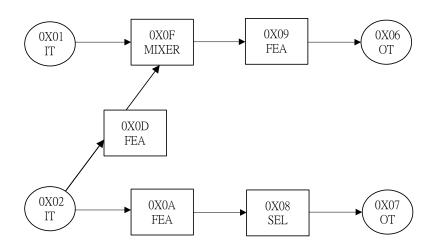
7 Function description

7.1 USB interface

The CM108B integrates USB transceiver, PLL and regulator modules, meaning only a few passive components are necessary for USB interface connection. Default USB descriptors are embedded in the CM108B, so no additional design effort is needed for generic USB operation. For custom orders, customers can attach a 93C46 EEPROM to override the embedded VID, PID, product and manufacturer strings, and initial/max/min volume settings. The CM108B automatically detects the 93C46, and the overwrite function is performed at start up.

7.1.1 USB audio topology diagram for headset

The CM108B supports headset and speaker topology that can be selected by MODE pin. The topology setting as following: MODE=0, Headset Topology; MODE=1, Speaker Topology



Device Descriptor

Offset	Field	Size	Value (Hex)	Description
0	bLength	1	12	Total 18 Bytes
1	bDescriptorType	1	01	Device Descriptor
2	bcdUSB	2	0110	USB 1.1 compliant.
4	bDeviceClass	1	00	Device class specified by interface
5	bDeviceSubClass	1	00	Device subclass specified by interface
6	bDeviceProtocol	1	00	Device protocol specified by interface
7	bMaxPacketSize0	1	8	Endpoint zero Size = 8 bytes
8	idVendor	2	0d8c	Vendor ID
10	idProduct	2	0012	Product ID
12	bcdDevice	2	0100	Device compliant to the Audio Device Class specification version 1.00
14	iManufacturer	1	01	Index of string descriptor describing manufacturer
15	iProduct	1	02	Index of string descriptor describing product
16	iSerialNumber	1	00	Index of string descriptor describing the device's serial number
17	bNumConfigurations	1	01	Configurations number = 1

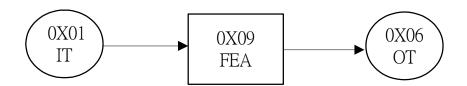
Configuration Descriptor

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Offset	Field	Size	Value (Hex)	Description
0	bLength	1	09	Total 9 Bytes
1	bDescriptorType	1	02	Configuration Descriptor
2	wTotalLength	2	XXXX	Total length of data returned for this configuration: Programmable by MSEL and MODE pin
4	bNumInterfaces	1	04	Number of interfaces supported by this Configuration: 0: control interface
5	bConfigurationValue	1	01	Configuration value
6	iConfiguration	1	00	Index of string descriptor describing this configuration
7	bmAttributes	1	80	Bus Power and support Remote Wakeup
8	bMaxPower	2	32	Maximum power consumption of the USB Device: 100mA

7.1.2 USB audio topology diagram for speaker



Device Descriptor

Offset	Field	Size	Value (Hex)	Description
0	bLength	1	12	Descriptor length
1	bDescriptorType	1	01	Device Descriptor
2	bcdUSB	2	0110	USB 1.1 compliant
4	bDeviceClass	1	00	Device class specified by interface
5	bDeviceSubClass	1	00	Device subclass specified by interface
6	bDeviceProtocol	1	00	Device protocol specified by interface
7	bMaxPacketSize0	1	08	Endpoint zero packet size
8	idVendor	2	0d8c	Vendor ID
10	idProduct	2	0012	Product ID
12	bcdDevice	2	0100	Device release number
14	iManufacturer	1	01	Index of string descriptor describing manufacturer
15	iProduct	1	02	Index of string descriptor describing product
16	iSerialNumber	1	00	Index of string descriptor describing serial number
17	bNumConfigurations	1	01	Number of configuration

Configuration Descriptor

Offset	Field	Size	Value (Hex)	Description
0	bLength	1	09	Descriptor length
1	bDescriptorType	1	02	Configuration Descriptor
2	wTotalLength	2	XXXX	Total length of data returned for this configuration: Programmable by MSEL and MODE pin
4	bNumInterfaces	1	03	Number of interfaces supported by this Configuration: 00: Control 01: ISO-Out 02: INT-IN (HID)
5	bConfigurationValue	1	01	Configuration value
6	iConfiguration	1	00	Index of string descriptor describing this configuration
7	bmAttributes	1	80	Attributes(PWRSEL=0:Bus Powered, 1:SELF Powered)
8	bMaxPower	1	32	Maximum power consumption from bus = 100mA

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7.1.3 Content format for EEPROM (93C46)

Each address has 2-byte data, prefix `0x` means hex number

Address(Hex)		Description					
0x00	bit[3] The value within bit[2] reserved, should	bit[15:4] Magic Word 0x670X where X = bit 4, 3, 2, 1 bit[3] The value within address 0x2A, 0x2B, 0x32 is valid 1: valid 0: invalid bit[2] reserved, should be 1 bit[1] serial number enable control 1: enable, 0: disable(default)					
0x01	VID 2-byte	DC 1					
0x02	PID 2-byte						
0x03	Serial number 1st byte (bit15-bit8, first character)	Serial number length (bit7-bit0)					
0x04	- Crianactory						
~	Serial number 12-byte						
0x09	ĺ						
0x0A	Product string 1st byte (bit15-bit8, first character)	Product string length (bit7-bit0) [0x3E->30,0x40->31Char]					
0x0B							
~	Product string 30-byte	(default: USB Audio Device)					
0x19							
0x1A	Manufacturer string 1st byte (bit15-bit8, first character)	Manufacturer string length (bit7-bit0) [0x3E->30,0x40->31Char]					
0x1B	,						
~	Manufacturer string 30	-byte (default: C-Media Electronics Inc.)					
0x29							
0x2A	bit[15: 9] DAC initial volume (7-bit, default = -10dB) bit[8: 3] ADC initial volume (6-bit, default = 8dB) bit[2] DAC EEPROM MAX/MIN volume valid bit[1] ADC EEPROM MAX/MIN volume valid bit[0] AA EEPROM MAX/MIN volume valid						
0x2B	bit[10] Reserved, should bit[9] Boost mode 0: 5 bit[8] Shout down DAC bit[7] Total Power Cont bit[6] Reserved, should bit[5] MIC High Pass Fill bit[4] MIC PLL Adjust bit[3] MIC BOOST bit[2] DAC Output Term 1: Headset, 0: Speake	22dB 1:12dB (default) analog circuits 1: shoutdown, 0: active(default) rol 1:enable, 0:disable(default) be 0					
0x2C		Volume (0xD300, DAC-Min.=-37dB, default=-37dB)					
0x2D		n Volume (0x0000, DAC-Max.=0dB, default=0dB)					
0x2E		Volume(0xEA00, ADC-Min.=-22dB, default=-12dB)					
0x2F		volume(0x1700, ADC-Max.=+23dB, default=+23dB)					
0x30		Volume (0xE900, AA-Min.=-23dB, default=-23dB)					
0x31		N Volume (0x0800,AA-Max.+8dB, default=+8dB)					
0x32	EE_OPTION2 Register bit[3] Reserved, should bit[2] Reserved, should	be 0					

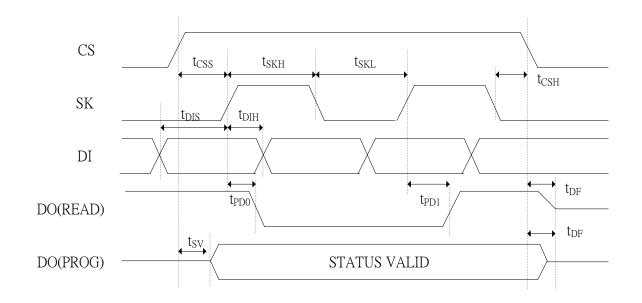
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	bit[1] Reserved, should be 0 bit[0] Reserved, should be 0
~ END	

7.1.4 EEPROM SPI interface timing information



Symbol	Parameter	Test Condition*	Min	Тур	Max	Units
f _{SK}	SK Clock Frequency	2.7V<=Vcc<=5.5V	0	-	200	KHz
t _{SKH}	SK High Time	2.7V<=Vcc<=5.5V	250	-	-	ns
t _{SKL}	SK Low Time	2.7V<=Vcc<=5.5V	250	-	-	ns
t _{CS}	Minimum CS Low Time	2.7V<=Vcc<=5.5V	250	-	-	ns
t _{CSS}	CS Setup Time	2.7V<=Vcc<=5.5V	50	-	-	ns
t _{DIS}	DI Setup Time	2.7V<=Vcc<=5.5V	100	-	-	ns
t _{CSH}	CS Hold Time	2.7V<=Vcc<=5.5V	0	-	-	ns
t _{DIH}	DI Hold Time	2.7V<=Vcc<=5.5V	100	-	-	ns
t _{PD1}	Output Delay to"1"	2.7V<=Vcc<=5.5V	-	-	250	ns
t _{PD0}	Output Delay to"0"	2.7V<=Vcc<=5.5V	-	-	250	ns
t _{sv}	CS to Status Valid	2.7V<=Vcc<=5.5V	-	-	250	ns
t _{DF}	CS to DO in High Impedance	2.7V<=Vcc<=5.5V	-	-	100	ns
t _{WP}	Write Cycle Time	4.5V<=Vcc<=5.5V	0.1	3	10	ms

^{*} based on ATMEL 93C46 EEPROM data

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7.2 Jumper pins and mode setting:

The CM108B can be configured via several jumper pins. These jumper pin settings affect both USB descriptors and USB audio topology.

7.2.1 Mode pin and msel pin

If the MODE pin is pushed up to 3.3V (speaker mode), a playback-only function is activated and no recording function is declared to the host. At this setting, the MSEL pin is ignored and only one input terminal, one output terminal and one feature unit is declared in the USB audio topology.

If the MODE pin is pulled low (headset mode), a full-duplex playback and recording function is reported to the host. The MSEL pin setting activates one mixer unit and one feature unit.

- When MSEL = 1, the mixer is enabled (AA-path enabled), but with default mute setting
- When MSEL = 0, the mixer is disabled (AA-path disabled)

The above USB audio topology (7.1.4) is an example of headset mode with enabled mixer.

7.2.2 Mode pin and pwrsel pin

The PWRSEL pin affects the power configuration of the CM108B. Together with the MODE pin, there are a total of 4 programmable combinations.

Combinations		MODE		
Combine	20113	3.3V	GND	
DWDCEI	3.3V	Speaker mode: Playback only (100mA self-powered)	Headset mode: Playback and recording (100mA Bus-powered)	
PWRSEL	GND	Speaker mode: Playback only (500mA Bus-powered)	Headset mode: Playback and recording (500mA Bus-powered)	

USB Audio Topology Diagram

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7.3 HID feature

USB protocols can configure devices at startup or when they are plugged in at run time. These devices are categorized into various device classes. Each device class defines the common behavior and protocols for devices that serve similar functions. The HID (Human Interface Device) class is one of the device classes.

The HID class consists primarily of devices that are used to control the operation of computer systems. Typical examples of HID class devices include:

The CM108B's HID feature allows users to set volume up, volume down, playback mute and recording mute button pins, and reports the changes to the host to synchronize host side settings. In addition, all CM108B internal registers can be accessed via HID function call.

7.3.1 HID descriptors

HID Interface Descriptor

Offset	Field	Size	Value (Hex)	Description
0	bLength	1	09	Size of this descriptor: 9 bytes
1	bDescriptorType	1	04	Interface descriptor type
2	bInterfaceNumber	1	03	Interface number: 3
3	bAlternateSetting	1	00	Alternate: 0
4	bNumEndpoints	1	01	Number of endpoints used by this interface: 1
5	bInterfaceClass	1	03	Interface class: HID
6	bInterfaceSubClass	1	00	Subclass: no
7	bInterfaceProtocol	1	00	Must be set to 0
8	ilnterface	1	00	String descriptor index that characterizes this interface

HID Descriptor

Offset	Field	Size	Value (Hex)	Description
0	bLength	1	09	Total: 9 bytes
1	bDescriptorType	1	21	HID descriptor type
2	bcdHID	2	0100	HID class version 1.0
4	bCountryCode	1	00	
5	bNumDescriptors	1	01	
6	bDescriptorType	1	22	Report descriptor
7	wDescriptorLength	2	003C	Total size of the optional descriptor: 60 bytes

Interrupt IN Endpoint Descriptor

Offset	Field	Size	Value (Hex)	Description
0	bLength	1	07	Total: 7 bytes
1	bDescriptorType	1	05	Endpoint descriptor type
2	bEndpointAddress	1	87	In Endpoint Number = 3
3	bmAttributes	1	03	Interrupt endpoint type
4	wMaxPacketSize	2	0004	Maximum packet size: 4 bytes
6	bInterval	1	2	2ms

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7.4 Internal Registers

All of CM108B's internal registers can be accessed via generic HID functional calls without the need to develop a kernel mode driver. In total, 4 bytes of data can be read or written from the HID. The input report is for read and the output report is for write. These internal registers of CM108B are used to control GPIO pins, S/PDIF output and EEPROM data access.

Access via HID Class Command

HID interrupt will occur when HID_IR0-3 are updated by button status, or GPI in case HID_IR0[7:6] == 2'b00).

HID Get_Input_Report Format

Command Format:

bmRequestType	bRequest	wValue	wIndex	wLength	Data
8'h A1	8'h 01 (Get_Report)	16'h 01 00 (Rpt Type + Rpt ID)	16'h 00 02 16'h 00 03 (Interface)	16'h 00 04 (4 bytes)	Report

Input Data Format:

byte 0	HID IR0[7:0]
byte1	HID IR1[7:0]
byte2	HID IR2[7:0]
byte3	HID IR3[7:0]

HID Set_Output_Report Format

Command Format:

bmRequestType	bRequest	wValue	wIndex	wLength	Data
8'h 21	8'h 09 (Set_Report)	16'h 02 00 (Rpt Type + Rpt ID)	16'h 00 02 16'h 00 03 (Interface)	16'h 00 04 (4 bytes)	Report

Output Data Format:

byte 0	HID OR0[7:0]
byte1	HID OR1[7:0]
byte2	HID OR2[7:0]
byte3	HID OR3[7:0]

HID_IR0 (HID input report byte 0)

Offset: 0x00

Bits	Read/Write	Description	Default
7-6	R	00: HID_IR1 is used as GPI, 10: values written to HID_IR0-3 are also mapped to EPROM_DATA0-1 and EEPROM_CTRL Others: reserved	0x0
5-4	R	Reserved	0x0
3	R	0: no activity on record/mute button 1: record/mute button pressed then released	0x0
2	R	0: no activity on playback/mute button 1: playback/mute button pressed then released	0x0
1	R	0: volume-down button released	0x0

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		1: volume-down button pressed	
0	D	0: volume-up button released	0x0
	"	1: volume-up button pressed	0.00

HID_IR1 (HID input report byte 1)

Offset: 0x01

Bits	Read/Write	Description	Default
		When HID_IR0[7:6] == 2'b00: HID_IR1[3:0] is the input from	
7-0	R	GPIO4 ~ GPIO1 in input mode	0x00
		When HID_OR0[7] == 1'b1: mapped from EEPROM_DATA0	

HID_IR2 (HID input report byte 2)

Offset: 0x02

Bits	Read/Write	Description	Default
7-0	R	When HID_OR0[7] == 1'b1: mapped from EEPROM_DATA1	0x00

HID_IR3 (HID input report byte 3)

Offset: 0x03

Bits	Read/Write	Description	Default
7-0	R	When HID_OR0[7] == 1'b1: mapped from EEPROM_CTRL	0x00

HID_OR0 (HID output report byte 0)

Offset: 0x04

Bits	Read/Write	Description	Default
7-6	R / W	0: HID_OR1-2 are used for GPO; HID_OR0, 3 are used for SPDIF 1: reserved 2: values written to HID_OR0-3 are also mapped to EEPROM_DATA0-1, EEPROM_CTRL (See Note) 3: reserved	0x0
5	R/W	Reserved	0x0
4	R/W	When HID_OR0[7] == 1'b0: valid bit in SPDIF frame When HID_OR0[7] == 1'b1: reserved	0x0
3-0	R/W	When HID_OR0[7] == 1'b0: first nibble of SPDIF status channel When HID_OR0[7] == 1'b1: reserved	0x0

<u>Note</u> 1: When EEPROM access is done, HID interrupt will occur. USB host can get the result from interrupt pipe (endpoint 3).

Note 2: HID_ORO is used for SPDIF when SPDIF_CONFIG[5] == 1'b0

HID_OR1 (HID output report byte 1)

Offset: 0x05

Bits	Read/Write	Description	Default
		When HID_OR0[7:6] == 2'b00: HID_OR1[3:0] is the output to	
		GPIO4 ~ GPIO1 in output mode	
7.0	R/W	0: GPO drives L	0x00
7-0	K / W	1: GPO drives H	UXUU
		When HID_OR0[7:6] == 2'b01: reserved	
		When HID_OR0[7:6] == 2'b1x: mapped to EEPROMDATA0	

HID_OR2 (HID output report byte 2)

Offset: 0x06

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Bits	Read/Write	Description	Default
7-0	R / W	When HID_OR0[7:6] == 2'b00: HID_OR2[3:0] is the mode setting for GPIO4 ~ GPIO1 0: set GPIO to input mode 1: set GPIO to output mode When HID_OR0[7:6] == 2'b01: reserved When HID_OR0[7:6] == 2'b1x: mapped to EEPROM_DATA1	0x00

HID_OR3 (HID output report byte 3)

Offset: 0x07

Bits	Read/Write	Description	Default
7-0	R/W	When HID_OR0[7] == 1'b0: category byte of SPDIF status channel When HID_OR0[7] == 1'b1: mapped to EEPROM_CTRL	0x00

Note: HID_OR3 is used for SPDIF when SPDIF_CONFIG[5] == 1'b0

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8 Electrical characteristics

8.1 Absolute maximum rating

Symbol	Parameters	Value	Unit
Dvmin	Min. digital supply voltage	- 0.3	V
Dvmax	Max. digital supply voltage	+ 6	V
Avmin	Min. analog supply voltage	- 0.3	V
Avmax	Max. analog supply voltage	+ 6	V
Dvinout	Voltage on any digital input or output pin	-0.3 to +5.5	V
Avinout	Voltage on any analog input or output pin	-0.3 to +3.96	V
TBstgB	Storage temperature range	-40 to +125	°C
ESD (HBM)	ESD human body mode	+-4000	V
ESD (MM)	ESD machine mode	+-200	٧
Latch Up	JEDEC standard no.78, Mar. 1997	200	mA

8.2 Operation conditions

	Operation	conditions		
	Min	Тур	Max	Unit
Analog supply voltage	4.5	5.0	5.5	V
Digital supply voltage	4.5	5.0	5.5	V
Total power consumption	-	37.25		mA
Suspend-mode power consumption	-	1.58		uA
Operating ambient temperature	-20	-	70	°C

8.3 Electrical parameters

	Min.	Тур.	Max.	Unit
	DAC (10K O	hm Loading)		
Resolution	-	16	-	Bits
THD + N (-3dBr) @1KHz	-	-72	-	dB
SNR	-	93	-	dB
Silent SNR	-	98	-	dB
Dynamic range	-	92	-	dB
Frequency response 48KHz	20	-	20K	Hz
Frequency response 44.1KHz	20	-	20K	Hz
Full Scale Output voltage (rms)	-	0.995	-	Vrms
	DAC (32 OI	nm loading)		
Resolution	-	16	-	Bits
THD + N (-3dBr) @1KHz	-	-70	-	dB
SNR	-	93	-	dB
Silent SNR	-	98	-	dB
Dynamic range	-	92	-	dB
Frequency response 48KHz	20	-	20K	Hz
Frequency response 44.1KHz	20	-	20K	
Full Scale Output voltage (rms)	-	0.442	-	Vrms
	Output Vol	ıme Control		
Volume Control Initial Value		-10		dB

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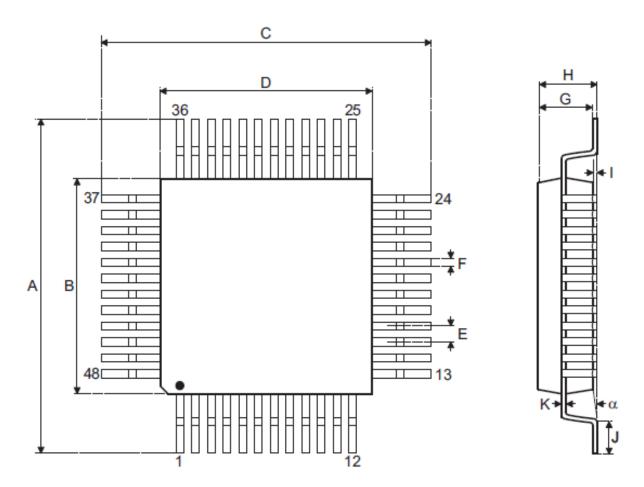
Volume Control Level	-37	-	0	dB
Volume Control Step	-	38	-	Steps
		ADC		
Resolution	-	16	-	bit
THD + N (-3dBr) @1KHz	-	-84	-	dB
SNR	-	90	-	dB
Dynamic range	-	88.5	-	dB
Frequency response 48KHz	100	-	20K	Hz
Frequency response 44.1KHz	100	-	20K	Hz
Input range	0	-	2.88	Vpp
	Micro	phone Input		
Boost gain	-	12/22 (EEPROM)	-	dB
Gain Adjustment Initial Value		8		dB
Gain adjustment range	-12	-	23	dB
Gain adjustment steps	-	36	-	Steps
Mixer Gain Initial Value		-7		dB
Mixer gain adjustment	-23.0	-	8.0	dB
Mixer gain adjustment steps	-	32	-	Steps

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9 Package information

48-Lead Thin Plastic Quad Flatpack (LQFP)



Symbol		Dimensions in mm			
	Minimum	Normal	Maximum		
Α	8.90	_	9.10		
В	6.90	_	7.10		
С	8.90	_	9.10		
D	6.90	_	7.10		
E	_	0.50	_		
F	_	0.20	_		
G	1.35	_	1.45		
Н	_	_	1.60		
	_	0.10	_		
J	0.45	_	0.75		
K	0.10	-	0.20		
α	0°	_	7°		

Note: Outline Dimensions are shown in millimeters



Reference

- USB specification 1.1 and 2.0-compliant
- USB audio device class specification 1.0-compliant
- USB human interface device class specification 1.11-compliant

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-End of Datasheet-

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